

BGAE340 | eMMC | 153-ball/100-ball

SMART's BGAE340 eMMC is an embedded memory solution that combines 2D-MLC NAND Flash Memory, an embedded MMC (MultiMediaCard) controller, and advanced firmware in a small BGA (Ball Grid Array) package that provides a stable, yet cost effective high-density embedded storage.

SMART's BGAE340 eMMC is compliant to eMMC v5.1 specifications and is available in the standard JEDEC 0.5mm pitch, 153-ball BGA package, as well 1.0mm pitch, 100-ball BGA package. eMMC can simplify system design because of the widely adopted JEDEC® eMMC standard interface in host system chipsets and operating system software driver support.



Features & Benefits

- Compliant to JEDEC v5.1 Standard
- Industrial Temp (-40°C to +85°C) & Wide Temp (-40°C to +105°C)
- Supports Write Protect and Secure Write Protection
- Supports eMMC Device Health Report

Applications

- Factory Automation
- IIoT
- Medical Devices
- Networking Appliances
- POS Terminals
- RFID Scanners
- Single-Board Computers
- Telecom Infrastructure

Product Family Overview

| Form Factor | Capacity | Sequential Performance |
|----------------|-------------|--|
| BGAE340 (MLC) | 8GB to 16GB | Up to 285MB/s Read Up to 94MB/s Write |
| BGAE340 (pSLC) | 2GB to 4GB | Up to 250MB/s Read Up to 65MB/s Write |

Specifications (BGAE340 MLC)

| | BGAE340 MLC 100-ball | | |
|-------------------------------|---|--|--|
| NAND Type | MLC | | |
| Performance | | | |
| Host Interface Rate (maximum) | eMMC v5.1 (HS400) | | |
| Capacities | 8GB to 16GB | | |
| Sequential Read (maximum) | Up to 285MB/s | | |
| Sequential Write (maximum) | Up to 94MB/s | | |
| Random Read (maximum) | Up to 7290 IOPS | | |
| Random Write (maximum) | Up to 2387 IOPS | | |
| Reliability | | | |
| Endurance | 16GB: 40 TBW | | |
| (Sequential Workload) | 8GB: 20 TBW | | |
| Data Retention | 10 years | | |
| Error Correction | BCH | | |
| Power | | | |
| Input Voltage | 3.3V ± 10% | | |
| Environmental | | | |
| Operating Shock | 1500 g half-sine, 0.5 msec, 1 shock along each axis, X, Y, Z in each direction | | |
| Operating Vibration | 20G 80-2000Hz, 1.52mm 20-80Hz, 3 axis | | |
| Operating Temperature | Industrial: -40°C to +85°C Wide: -40°C to 105°C | | |
| | -40°C to +85°C (for I-Temp) | | |
| Storage Temperature | -40°C to +105°C (for W-Temp) | | |
| Physical | | | |
| Length | 14 mm | | |
| Width | 18 mm | | |
| Height | 2.45 mm | | |

Ordering Information (BGAE340 MLC)

| Part Number | Density | | |
|--|---------|--|--|
| BGAE340 MLC eMMC 100-ball Industrial Operating Temperature (-40°C to +85°C) | | | |
| SPQ8GH2AHI01 | 8GB | | |
| BGAE340 MLC eMMC 100-ball Wide Operating Temperature (-40°C to +105°C) | | | |
| SP9QAGH2AHW01 | 16GB | | |
| SP9Q8GH2AHW01 | 8GB | | |

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Specifications (BGAE340 pSLC)

| | BGAE340 pSLC 153-ball | BGAE340 pSLC 100-ball |
|-------------------------------|--|-------------------------|
| NAND Type | pSLC | |
| Performance | | |
| Host Interface Rate (maximum) | eMMC v5.1 (HS400) | |
| Capacities | 2GB to 4GB | |
| Sequential Read (maximum) | Up to 250MB/s | |
| Sequential Write (maximum) | Up to 65MB/s | |
| Random Read (maximum) | Up to 10000 IOPS | |
| Random Write (maximum) | Up to 2000 IOPS | |
| Reliability | | |
| Endurance | 4GB: 100 TBW | |
| (Sequential Workload) | 2GB: 50 TBW | |
| Data Retention | 10 years | |
| Error Correction | BCH | |
| Power | | |
| Input Voltage | 3.3V ± 10% | |
| Environmental | | |
| | 1500 g half-sine, 0.5 msec, 1 shock along each axis, | |
| Operating Shock | X, Y, Z in each direction | |
| Operating Vibration | 20G 80-2000Hz, 1.52mm 20-80Hz, 3 axis | |
| Operating Temperature | Industrial: -40°C to +85°C | |
| | Wide: -40°C to +105°C | |
| Storage Temperature | -40°C to +85°C | |
| Physical | | |
| Length | 11.5 mm | 14 mm |
| Width | 13 mm | 18 mm |
| Height | 1 mm | 2.45 mm |

Ordering Information (BGAE340 pSLC)

| Part Number | Density | | |
|---|---------|--|--|
| BGAE340 pSLC eMMC 153-ball Industrial Operating Temperature (-40°C to +85°C) | | | |
| SPM8GH2AHI11 | 4GB | | |
| SP9M4GH1AHI11 | 2GB | | |
| BGAE340 pSLC eMMC 100-ball Industrial Operating Temperature (-40°C to +85°C) | | | |
| SPQ8GH2AHI11 | 4GB | | |
| SPQ4GH1AHI11 | 2GB | | |
| BGAE340 pSLC eMMC 153-ball Wide Operating Temperature (-40°C to +105°C) | | | |
| SPM8GH2AHW11 | 4GB | | |



For more information, please visit: www.smartm.com

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